

Dual P-Channel MOSFET

DESCRIPTION

SMC4953A is the Dual P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance. This device is ideal for load switch applications.

PART NUMBER INFORMATION

SMC **4953A** **M** - **TR** **G**
 a b c d e

- a : Company name.
- b : Product Serial number.
- c : Package code M: SOP-8
- d : Handling code TR: Tape & Reel
- e : Green produce code G: *RoHS Compliant*

FEATURES

$V_{DS} = -30V$, $I_D = -5A$

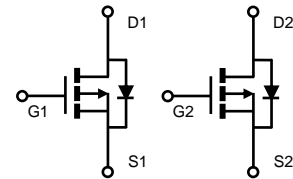
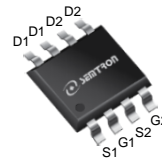
$R_{DS(ON)} = 46m\Omega (Typ.) @ V_{GS} = -10V$

$R_{DS(ON)} = 65m\Omega (Typ.) @ V_{GS} = -4.5V$

- ◆ Fast switch
- ◆ High power and current handling capability

APPLICATIONS

- ◆ DC-DC Power System
- ◆ Load Switch



SOP-8

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	-30	V
V_{GSS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current	$T_A = 25^\circ C$	-5
		$T_A = 70^\circ C$	-4
I_{DM}	Pulsed Drain Current ^A	-20	A
P_D	Power Dissipation ^B	$T_A = 25^\circ C$	2
		$T_A = 70^\circ C$	1.3
T_J	Operation Junction Temperature	-55/150	$^\circ C$
T_{STG}	Storage Temperature Range	-55/150	$^\circ C$

THERMAL RESISTANCE

Symbol	Parameter	Typ	Max	Units
$R_{\theta JA}$	Thermal Resistance Junction to Ambient ^B	Steady-State	62	$^\circ C/W$
	Thermal Resistance Junction to Ambient ^{BC}		110	
$R_{\theta JC}$	Thermal Resistance Junction to Case		45	

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

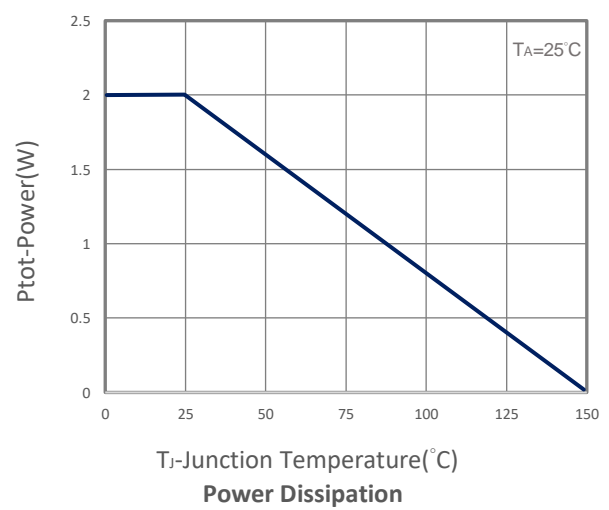
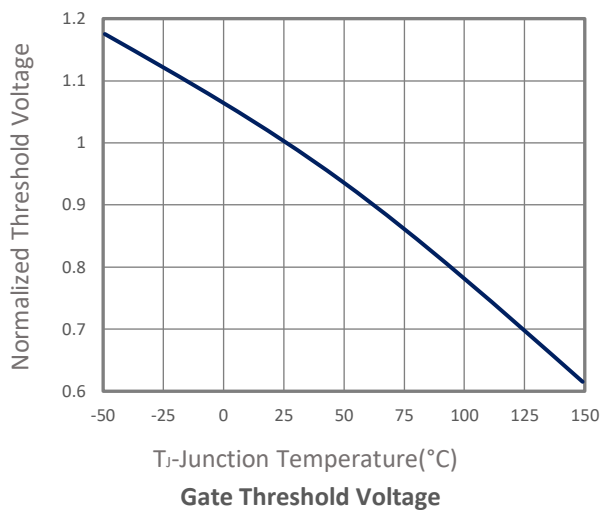
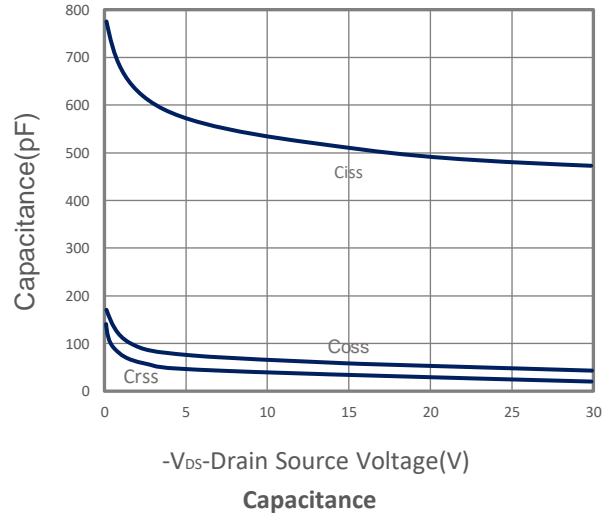
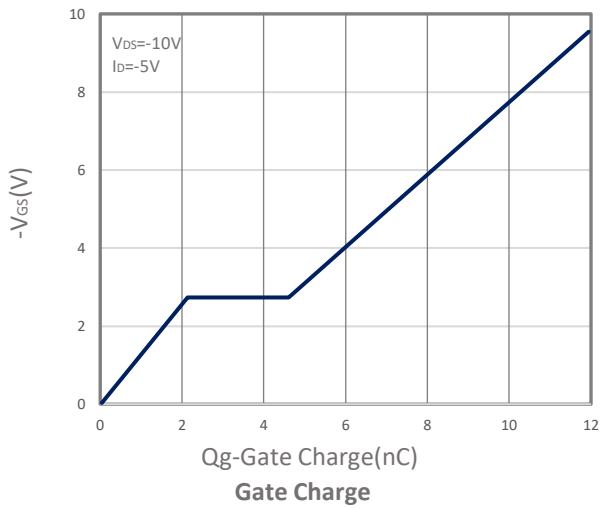
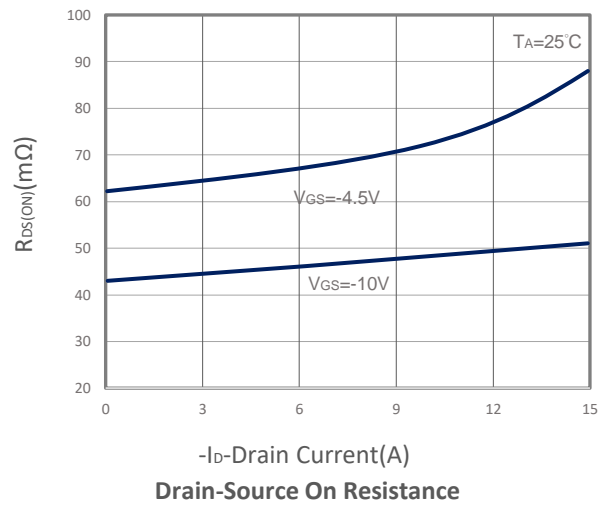
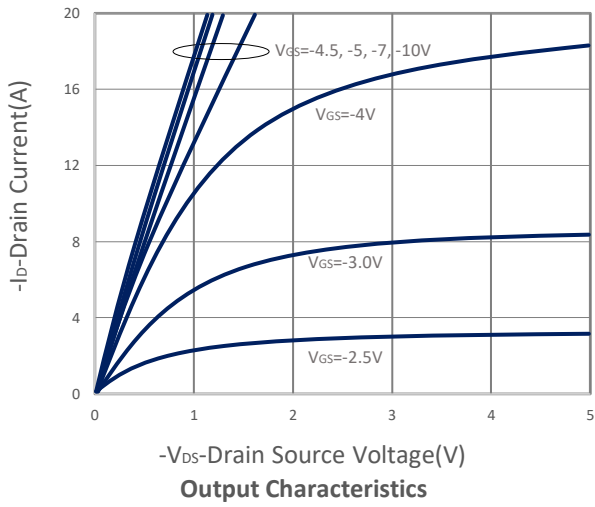
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250 μ A	-30			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250 μ A	-1	-1.6	-2.5	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} = \pm 20V			\pm 100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V, T _J =25 $^\circ$ C			-1	μ A
		V _{DS} =-24V, V _{GS} =0V, T _J =75 $^\circ$ C			-10	
R _{DS(ON)}	Drain-source On-Resistance	V _{GS} =-10V, I _D =-5A		46	52	m Ω
		V _{GS} =-4.5V, I _D =-3.6A		65	75	
G _{fs}	Forward Transconductance	V _{DS} =-10V, I _D =-5A		17		S
Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _S =-1A, V _{GS} =0V		-0.7	-1	V
I _S	Diode Continuous Forward Current				-2.5	A
Dynamic and Switching Parameters						
Q _g	Total Gate Charge	V _{DS} =-15V, V _{GS} =-10V, I _D =-5A		12.6	17.6	nC
Q _g	Total Gate Charge (4.5V)			6.3	8.8	
Q _{gs}	Gate-Source Charge			2.1	2.9	
Q _{gd}	Gate-Drain Charge			2.3	3.2	
C _{iss}	Input Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1MHz		512	717	pF
C _{oss}	Output Capacitance			52	73	
C _{rss}	Reverse Transfer Capacitance			43	60	
t _{d(on)}	Turn-On Time	V _{DD} =-15V, V _{GEN} =-10V R _G =3.3 Ω , I _D =-1A		7.5	14	nS
t _r				10	19	
t _{d(off)}	Turn-Off Time			16	30	
t _f				6	11	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

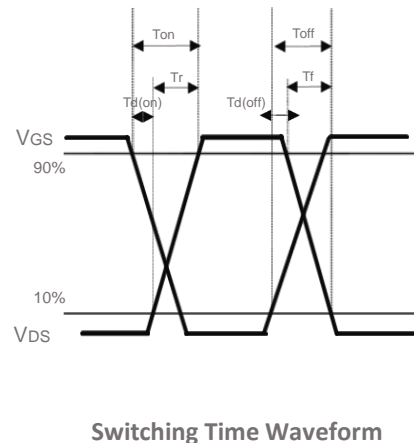
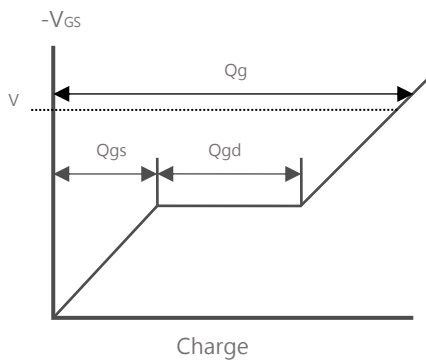
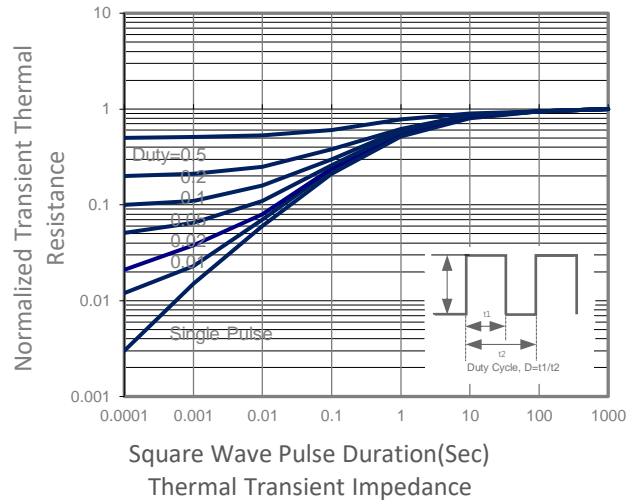
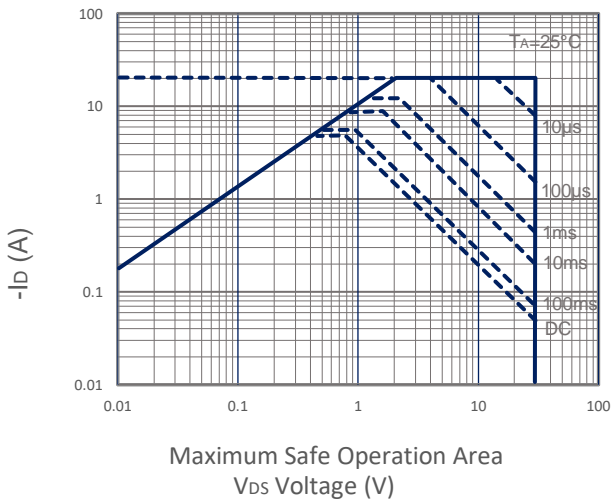
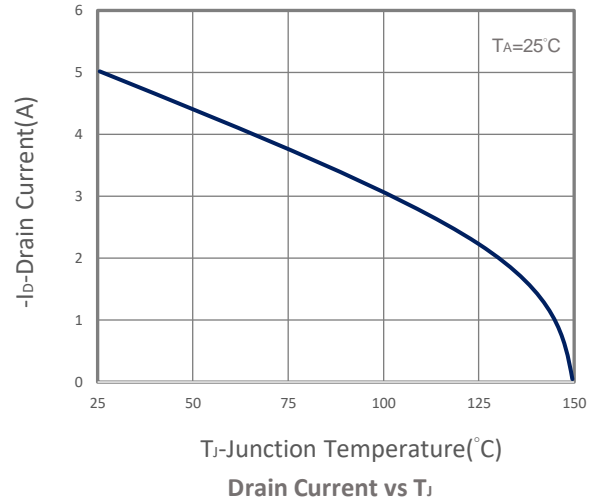
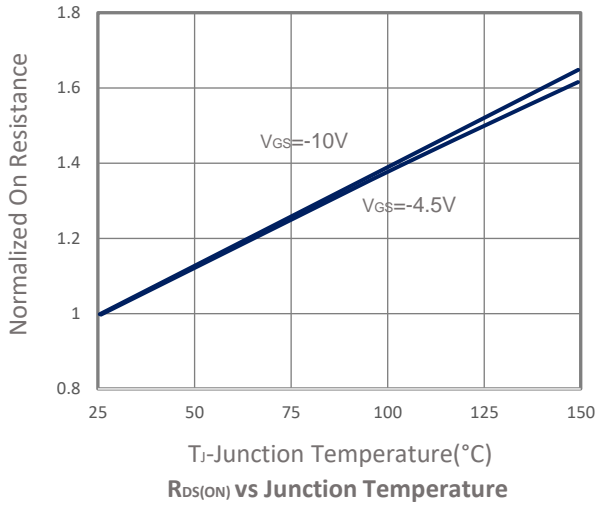
- Pulsed width limited by maximum junction temperature, T_{J(MAX)}=150 $^\circ$ C.
- The value of R θ _{JA} is measured with the device mounted on 1in2 FR-4 board in a still air environment with maximum junction temperature T_{J(MAX)}=150 $^\circ$ C (initial temperature T_A=25 $^\circ$ C).
- T_{J(MAX)}=150 $^\circ$ C, using junction-to-case thermal resistance (R θ _{JC}) is more useful in additional heat sinking is used.

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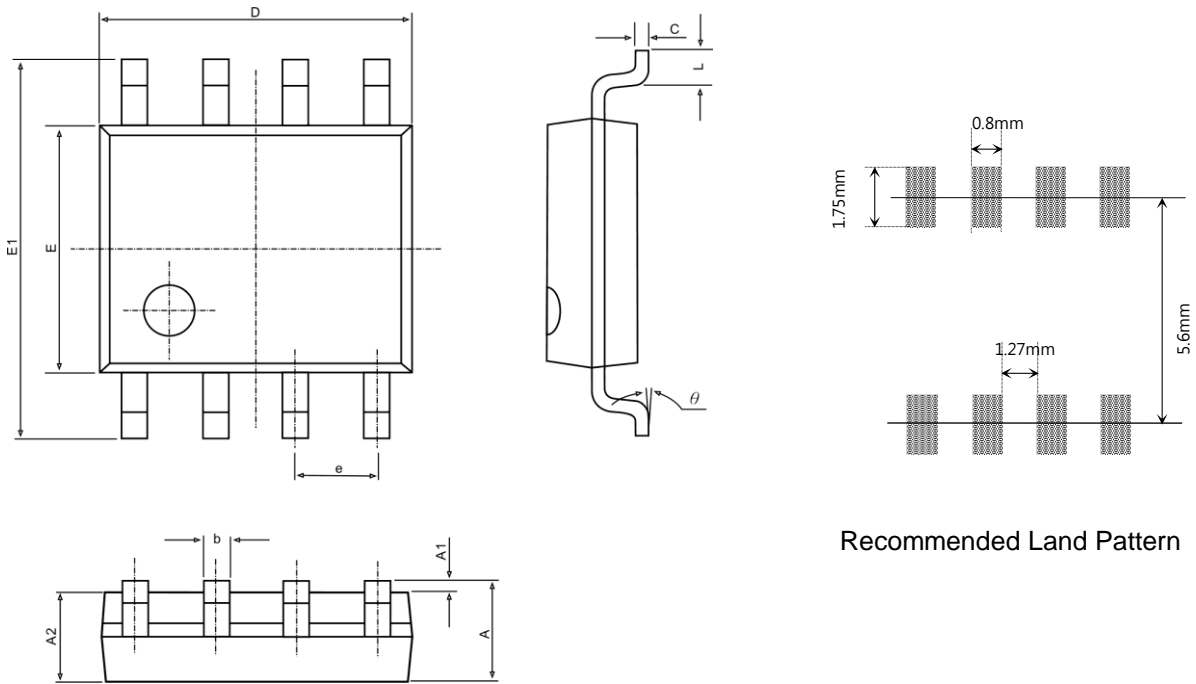
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



■ SOP-8 PACKAGE DIMENSIONS



Recommended Land Pattern

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.040	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.130	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270BSC.		0.050BSC.	
L	0.400	1.270	0.016	0.005
θ	0°	8°	0°	8°